



2823

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Madhav Datta et al.  
Title: COPPER-CONTAINING C4 BALL-LIMITING METALLURGY STACK FOR ENHANCED RELIABILITY OF  
PACKAGED STRUCTURES AND METHOD OF MAKING SAME

Docket No.: 884.522US1 Serial No.: 09/961,034  
Filed: September 21, 2001 Due Date: October 4, 2002  
Examiner: Long Pham Group Art Unit: 2823

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Commissioner for Patents  
Washington, D.C. 20231

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 Response to Restriction Requirement (4 Pages).

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By: Ann M. McCrackin  
Atty: Ann M. McCrackin  
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**CERTIFICATE UNDER 37 CFR 1.8:** The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on this 3 day of October, 2002.

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P.O. Box 2938, Minneapolis, MN 55402 (612-373-6900)  
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